

Title (en)

Electro-plating process and products therefrom.

Title (de)

Verfahren zur elektrolytischen Plattierung und dadurch hergestellte Produkte.

Title (fr)

Procédé d'électro-déposition et produits ainsi obtenus.

Publication

**EP 0063925 A1 19821103 (EN)**

Application

**EP 82302060 A 19820422**

Priority

GB 8112666 A 19810424

Abstract (en)

A process for electro-plating a selected surface area of an electrical connector contact element (2), e.g. of copper alloy, comprising electro-plating the connector in the absence of a masking (1) element to give the required thickness of plating material in the selected area, (3) applying a masking element, such as a pin or sheath, to the selected area of the connector where the plating material is to be retained, and stripping the plating material from the unmasked parts of the connector so that the connector remains plated in the selected area only. The process is especially applicable to connectors suitable for use in the assembly of computers.

IPC 1-7

**C25D 5/02**

IPC 8 full level

**C25D 5/02** (2006.01)

CPC (source: EP)

**C25D 5/02** (2013.01)

Citation (search report)

- [X] GB 1485083 A 19770908 - STANDARD TELEPHONES CABLES LTD
- [A] FR 1287563 A 19620316

Cited by

DE3447032C1; WO8607205A1

Designated contracting state (EPC)

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**EP 0063925 A1 19821103**; GB 2097426 A 19821103; GB 2097426 B 19840118

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